Serial No. 10/802,563

September 2, 2008

To: Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Fr:

Stephen B. Ackerman, Reg. No. 37,761

28 Davis Avenue

Poughkeepsie, N.Y. 12603

Subject:

Serial No.

10/802,563

03/17/04

Hong Yu Yu et al

"A THERMAL ROBUST SEMICONDUCTOR DEVICE USING HFN AS METAL GATE ELECTRODE AND THE MANUFACTURING PROCESS THEREOF"

Grp. Art Unit: 2823

SU C. KIM

RESPONSE PATENT OFFICE ACTION

Dear Sir:

In response to the Office Action dated April 3, 2008, please amend the above-identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on September 3, 2008.

Stephen B Ackernman Reg. 1

Signature

Date Sectember 3,2008

Amendments to the Claims are reflected in the listing of the Claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 10 of this paper.